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# $Ni_xCu_{6-x}Sn_5$ alloys as negative electrode materials for rechargeable lithium batteries

Jing-jun Zhang, Yi-min Zhang, Xiao Zhang, Yong-yao Xia\*

Chemistry Department and Shanghai Key Laboratory of Molecular Catalysis and Innovative Materials, Fudan University, Shanghai 200433, China

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#### Abstract

A series of Ni doped Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x=0, 0.5, 1, 2, 4) alloys were prepared by mechanical alloying, followed by annealing at 400 °C. The Ni doped alloys show the similar structure with that of Cu<sub>6</sub>Sn<sub>5</sub> and Ni<sub>3</sub>Sn<sub>2</sub>, which can be indexed to a hexagonal Ni<sub>2</sub>In type cell, but differ in the electrochemical performance as the anodes of Li-ion batteries. The electrochemical tests show that the cycling reversibility of Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> increases at the expense of the reversible capacity with the increasing amount of Ni content. The proper amount Ni doped alloy, Ni<sub>2</sub>Cu<sub>4</sub>Sn<sub>5</sub> showed better cycle performance with a reversible capacity of 200 mAh g<sup>-1</sup> (1680 mAh ml<sup>-1</sup>). The relative stability of the alloy was also investigated using the first-principles density-functional theory with pseudopotentials and plane wave basis (VASP). © 2007 Elsevier B.V. All rights reserved.

Keywords: Alloys; Intermetallic compound; Tin; Lithium-ion batteries; First-principle calculation

#### 1. Introduction

Metals and alloys present attractive alternatives to graphite as the anode materials for lithium-ion batteries due in particular to the high capacity, an acceptable rate capability, and operating potentials well above the potential of metallic lithium. In particular, the intermetallic compounds (M'M) show the most promising attentions [1–7]. It typically consists of an "inactive phase M'", which is referred to that does not react with lithium, and "active phase M", which is referred to that reacts with lithium. Introducing an "inactive phase, M'" can reduce the volume expansion/contraction in some extent, thus improving its cycling performance. According to the lithium-ion alloying mechanism, the alloys can be divided into two groups: the first one is referred to those alloys in which the reaction of lithium results first in the formation of  $Li_{x}M'M$  as an intermediate phase, with further reaction leads to a mixed phase of the disordered Li<sub>x</sub>M alloy and metal M', and the initial intermetallic alloys are reformed when lithium was extracted from the alloys during charge, such as  $Cu_6Sn_5$  [1,2], InSb [3,4], etc.; and the other

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one is referred to these alloys in which the reaction of lithium in the M'M results directly in the formation of a disordered  $Li_xM$  alloy and metal M' matrix, but M' cannot recombine with M to reform the initial intermetallic compounds during the charge, such as Sn-Mn [5], Sn-Fe [6], Co-Sn [7], etc. In the previous work, we studied the electrochemical performance of  $Co_rCu_{6-r}Sn_5$  which has both the group I (Cu) and group II (Co) inactive metals. We have found that a proper amount of Co doped alloy,  $CoCu_5Sn_5$ , has the same structure with  $Cu_6Sn_5$ , and showed improved cycling stability at the expense of the capacity [7]. Compared with Co-Sn alloys, the Ni-Sn alloys, including Ni<sub>3</sub>Sn<sub>4</sub>, Ni<sub>3</sub>Sn<sub>2</sub> and Ni<sub>3</sub>Sn, in particular, the Ni<sub>3</sub>Sn<sub>2</sub> and Ni<sub>3</sub>Sn alloys which have the same Ni<sub>2</sub>In-type structure with Cu<sub>6</sub>Sn<sub>5</sub>, are quite different in the electrochemical behavior from Co-Sn alloys: the pure crystalline Ni<sub>3</sub>Sn<sub>2</sub> alloys prepared by mechanical alloying method have small reversible capacity (ca.  $30 \text{ mAh g}^{-1}$  [8], ca.  $20 \text{ mAh g}^{-1}$  [9]) but very good cycle performance; the pure crystalline electroplated Ni<sub>3</sub>Sn<sub>2</sub> have a good cycle stability with a reversible capacity of 60-70 mAh g<sup>-1</sup> [10]. Although the lithium alloying mechanism is not clear, it seems that the lithiation reaction results in the formation of  $Li_x NiSn$ , rather than the mixture phases of  $Li_x Sn$  and Ni nanoparticles (lithium reaction with Co-Sn results in a mixture phase of Li<sub>4.4</sub>Sn and Co). In the present work, we used Ni to partly

<sup>\*</sup> Corresponding author. Tel.: +86 21 55664177; fax: +86 21 55664177. *E-mail address:* yyxia@fudan.edu.cn (Y.-y. Xia).

substitute Cu to prepare a series of Ni doped Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x = 0, 0.5, 1, 2, 4). The effects of doped-Ni amount on the structure and lithium intercalation were examined. The relationship between the electrochemical performance and the crystal structure was also studied by the first-principles calculation.

## 2. Experimental

#### 2.1. Preparation and characterization

A series of Ni doped  $Ni_xCu_{6-x}Sn_5$  (x=0, 0.5, 1, 2, 4) alloys, i.e.,  $Cu_6Sn_5$ ,  $Ni_{0.5}Cu_{5.5}Sn_5$ ,  $NiCu_5Sn_5$ ,  $Ni_2Cu_4Sn_5$  and  $Ni_4Cu_2Sn_5$  were synthesized by mechanical ball-milling stoichiometric amount of metallic powder Cu, Ni and Sn for 12 h under Ar atmosphere using a high-energy planetary mono mill pulverisette 6 (Fritsch GmbH Inc., Germany). After milling, the powders were pressed into pellets and heat-treated at 400 °C for 12 h under Ar flow in order to obtain single phase, well crystalline intermetallic compounds. The gray brittle products were then ground and sifted to approximately 400 mesh. The Ni–Sn alloys (Ni<sub>3</sub>Sn, Ni<sub>3</sub>Sn<sub>2</sub> and Ni<sub>3</sub>Sn<sub>4</sub>) were also prepared by the same process mentioned above from Ni and Sn metallic powders.

X-ray diffraction (XRD) patterns of the powdered samples were obtained using an X-ray diffractometer (Bruker Advance8) with Cu K $\alpha$  radiation. The diffraction data were collected at 0.015 step widths over a  $2\theta$  range from 20 to 85°. The structural parameters were refined by Rietveld analysis using the computer program RIETAN 2000. The structural model used is the Ni<sub>2</sub>Intype structure (space group  $P6_3/mmc$ , no. 194).

The electrodes were prepared by mixing 80% alloy powders, 10% carbon black and 10% polyvinylidene fluoride (PVDF) dissolved in N-methylpyrrolidinone (NMP). The slurries of the mixture were coated on Cu foil. After coating, the electrodes were dried at 80 °C for 10 min to remove the solvent before pressing. The electrodes were cut into sheets  $1 \text{ cm}^2$  in area, vacuum-dried at 100 °C for 24 h, and weighed. The typical weight load of active material is about  $5 \text{ mg cm}^{-2}$ . The battery performance of alloy was characterized in CR2032-type coin cell. Metallic lithium was used as the negative electrode. The electrolyte solution was 1 M LiPF<sub>6</sub>/ethlylene carbonate (EC)/dimethyl carbonate (DMC)/ethyl methyl carbonate (EMC) (1:1:1 by volume). The cells were cycled at a constant current density of 0.25 mA cm<sup>-2</sup> between 0.0 and 2.0 V. Lithium insertion into an alloy electrode was referred to as discharge and extraction as charge. The cell capacity was determined by only the alloy active material.

#### 2.2. Computational

To investigate the relative stability of the Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> alloys, we defined the formation energy of Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> alloys as the following functions:

$$E_{\rm f} = E_{\rm Ni_x Cu_{6-x} Sn_5} - \frac{6-x}{6} E_{\rm Cu_6 Sn_5} - \frac{x}{3} E_{\rm Ni_3 Sn_2} - \frac{x}{6} E_{\rm Sn} \quad (1)$$

where  $E_{\rm f}$  is the formation energy of Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> alloys and  $E_{\rm C}$  is the total energy of compound C. The total energy of

alloys Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x = 0, 1, 2, 3, 4, 5, 6), Ni<sub>3</sub>Sn<sub>2</sub> and metal Sn are calculated using the first-principles calculation based on the density-functional theory with pseudopotentials and plane wave basis (VASP) [11,12].

In order to investigate the difference of lithiation in alloys of  $Cu_6Sn_5$  and  $Ni_3Sn_2$ , we performed the relative energy calculations for the lithiated alloys of  $Li_xCu_6Sn_5$  and  $Li_xNi_3Sn_2$  in which the Li occupied in the high symmetric vacant sites, and the alloys of  $Li_xSn$  appeared in the lithiation process after the inert metal extracted from the alloy matrix. The relative energy for the compound  $Li_xM_ySn$  is given as:

$$E_{\rm r} = E_{{\rm Li}_x{\rm M}_y{\rm Sn}} + (4.4 - x)E_{{\rm Li}} - E_{{\rm Li}_{4.4}{\rm Sn}} - yE_{\rm M}$$
(2)

where  $E_r$  is the relative energy of  $Li_x M_y Sn$  alloys and  $E_C$  is the total energy of compound C.

The Cu<sub>6</sub>Sn<sub>5</sub> compound and the Ni doped alloys used in the computational study were chosen as a defect Ni<sub>2</sub>In type structure in which Sn occupying 2c (1/3, 2/3, 1/4) position and Cu (Ni) at the 2a (0, 0, 0) and 2d (1/3, 2/3, 3/4) positions of space group  $P6_3/mmc$ . The Cu (Ni) occupancy of the 2a position is 100% and 2d position was 20% for Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x=0, 1, 2, 3, 4, 5), every fifth trigonal bipyramidal site in the strings of Sn atoms [13]. For Ni<sub>3</sub>Sn<sub>2</sub>, the Ni occupancy of 2a is 100% and 2d is 50% [14]. The structure of metal Sn used in the calculation is tetragonal  $I4_1/amd$  (no. 141) [15].

The number of atoms per unit cells was 22 for Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x=0, 1, 2, 3, 4, 5) and 4 for metal Sn, depending on which the desired sets of *k*-points in reciprocal space were chosen. In all of the calculations, the convergence of the total energy with respect to *k*-point sampling and plane wave energy cutoff has been carefully examined. The final set of energies was computed with an energy cutoff of 500 eV for all compounds. The *k* point number of 62 and 196 for Co<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x=0, 1, 2, 3, 4, 5, 6) and metal Sn has been used, respectively, for the irreducible Brillouin zone integration.

## 3. Results and discussion

#### 3.1. Structure and cycle performance of Ni–Sn alloys

Fig. 1 shows the X-ray diffraction patterns of Ni<sub>3</sub>Sn, Ni<sub>3</sub>Sn<sub>2</sub> and Ni<sub>3</sub>Sn<sub>4</sub>. No Ni, Sn, or oxides diffraction peaks are observed, which are well agreement with the previous reports [8,9,16]. The Ni<sub>3</sub>Sn and Ni<sub>3</sub>Sn<sub>2</sub> can be indexed to the hexagonal  $P6_3/mmc$  structure, and the Ni<sub>3</sub>Sn<sub>4</sub> to the monoclinic C2/m structure. The capacity *versus* cycle number plots for the alloys are shown in Fig. 2. Small reversible capacity is observed for all the three alloys, while the cycle performance is very good, especially for the Ni<sub>3</sub>Sn<sub>2</sub>.

#### 3.2. Characterization of $Ni_xCu_{6-x}Sn_5$

As mentioned in Section 1, the Ni<sub>3</sub>Sn<sub>2</sub> and Ni<sub>3</sub>Sn alloys have the same Ni<sub>2</sub>Sn-type structure with Cu<sub>6</sub>Sn<sub>5</sub> which has relative high capacity of ca. 500 mAh g<sup>-1</sup>. We are interested in studying the electrochemical performance of Ni doped Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub>.



Fig. 1. Powder XRD patterns of Ni–Sn alloys: (a)  $Ni_3Sn,$  (b)  $Ni_3Sn_2$  and (c)  $Ni_3Sn_4.$ 

Fig. 3 compares the X-ray diffraction patterns of  $Ni_rCu_{6-r}Sn_5$ powders with that of Cu<sub>6</sub>Sn<sub>5</sub> and Ni<sub>3</sub>Sn<sub>2</sub>. As shown in Fig. 3, all patterns are very similar and can be ascribed to the signature peaks corresponding to the hexagonal structure  $P6_3/mmc$ . No peaks corresponding to Cu or Ni are detected. However, as a result of substituting Cu with Ni, the diffraction patterns are varied slightly. Firstly, it is obvious that the (002) and (004)peaks slightly shift to the small angle, while the other peaks shift to the large angle with increasing amount of doped-Ni content. Secondly, the two diffraction peaks, (110) and (102), around  $42^{\circ}$  overlap first and then split again with increasing amount of doped-Ni content. The peak of (110) shifts gradually from the left to (102) peak on Cu<sub>6</sub>Sn<sub>5</sub> pattern to the right to the (102) peak on the pattern of Ni<sub>3</sub>Sn<sub>2</sub>. It can be deduced that the shift amount of (110) peak is large than that of (102) peak. The lower intensity and broad peaks of Ni<sub>3</sub>Sn<sub>2</sub> indicate smaller particle size of Ni<sub>3</sub>Sn<sub>2</sub>.

In order to investigate the change of lattice parameters, we performed the Rietveld refinement. For the refinement, we use the same structure as the first-principles calculation described in the computational section. The refined lattice parameters are listed in Table 1. All patterns were fitted successfully to the model structure. The refinement results show that the lattice parameter a, and the cell volume decrease, while the



Fig. 2. Capacity vs. cycle number of Li/Ni–Sn alloy cells containing: (a)  $Ni_3Sn_4$ , (b)  $Ni_3Sn$  and (c)  $Ni_3Sn_2$  at a current of 0.25 mA cm<sup>-2</sup> between 0 and 1.2 V.



Fig. 3. Powder XRD patterns of  $Ni_xCu_{6-x}Sn_5$  alloys: (a)  $Cu_6Sn_5$ , (b)  $Ni_{0.5}Cu_{5.5}Sn_5$ , (c)  $NiCu_5Sn_5$ , (d)  $Ni_2Cu_4Sn_5$ , (e)  $Ni_4Cu_2Sn_5$  and (f)  $Ni_3Sn_2$ . The miller index for each peak of  $Cu_6Sn_5$  and  $Ni_3Sn_2$  is marked in the figure.

lattice parameter *c* increases with the increasing Ni content in  $Ni_xCu_{6-x}Sn_5$ .

Since the similarity of the crystal structure of  $Cu_6Sn_5$ and  $Ni_3Sn_2$ , it is important to see whether the Ni doped  $Ni_xCu_{6-x}Sn_5$  alloys consist of a single phases or multiphase coexistence of  $Cu_6Sn_5$  and  $Ni_3Sn_2$ . We applied the firstprinciples calculation to study their thermodynamic stability based on the density-functional theory with pseudopotentials and plane wave basis (VASP). The volume per formula unit and the formation energy of  $Ni_xCu_{6-x}Sn_5$  as defined in Section 2.2 are shown in Fig. 4(A and B). We can see that the cell volume per formula unit is decreases with increasing amounts of Ni in  $Ni_xCu_{6-x}Sn_5$  as shown in Fig. 4(A). This is well agreement with the results of XRD and the Rietveld refinement. The formation energy of  $Ni_xCu_{6-x}Sn_5$  is negative with respect to the sum of

Table 1	
Rietveld refinement results for $Ni_xCu_{6-x}Sn_5$	

Samples	Phase	Rietveld refinement results				
		a (=b) (Å)	c (Å)	$V(Å^3)$	<i>R</i> <sub>wp</sub> (%)	R <sub>p</sub> (%)
Cu <sub>6</sub> Sn <sub>5</sub>	P63/mmc	4.196	5.088	77.58	7.12	5.46
Ni0.5Cu5.5Sn5	P63/mmc	4.191	5.098	77.55	6.25	4.79
NiCu <sub>5</sub> Sn <sub>5</sub>	P63/mmc	4.181	5.104	77.27	4.92	3.77
Ni <sub>2</sub> Cu <sub>4</sub> Sn <sub>5</sub>	P63/mmc	4.147	5.118	76.23	5.46	4.12
Ni <sub>4</sub> Cu <sub>2</sub> Sn <sub>5</sub>	P63/mmc	4.086	5.134	74.23	5.79	4.29
Ni <sub>3</sub> Sn <sub>2</sub>	P6 <sub>3</sub> /mmc	4.090	5.186	75.13	6.23	4.72

*a*, *c* and *V* are the two lattice constants and cell volume of the structures, respectively.  $R_{wp}$  and  $R_p$  are the two quantities describing the goodness of fit and the agreement between the calculated and observed intensities, respectively.



Fig. 4. The cell volume per formula unit (A) and the calculated relative energy (B) for  $Ni_xCu_{6-x}Sn_5$  (x=0, 0.5, 1, 2, 4) and  $Ni_3Sn_2$ .

energies for  $(6-x)/6Cu_6Sn_5$ ,  $x/3Ni_3Sn_2$  and x/6Sn, suggesting that it is possible thermodynamically that the Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> form homogeneous solid matrix in a unit cell level rather than simple mixture of Cu<sub>6</sub>Sn<sub>5</sub>, Ni<sub>3</sub>Sn<sub>2</sub> and Sn crystals.

#### 3.3. Electrochemical performance

Fig. 5 shows the typical charge/discharge profiles of  $Cu_6Sn_5$ , Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> and Ni<sub>3</sub>Sn<sub>2</sub> alloy electrodes at a current rate of  $0.25 \text{ mA cm}^{-2}$  between 0.0 and 1.2 V. It is clear from Fig. 5(A) that Cu<sub>6</sub>Sn<sub>5</sub> reveals two plateaus on discharge (lithiation), one at about 0.4 V and the other below 0.15 V versus Li/Li<sup>+</sup>, corresponding to the transformation from hexagonal Cu<sub>6</sub>Sn<sub>5</sub> to the intermediate phase of cubic  $Li_xCu_6Sn_5$  and  $Li_{4.4-x}Sn + Cu$ phases. Accordingly, two regions are observed on the charge (delithiation), one below 0.5 V and the other between 0.5 and 0.8 V versus Li/Li<sup>+</sup>. The result is well agreement with the previous reports [1,2]. For the small Ni substituted alloys Ni<sub>0.5</sub>Cu<sub>5.5</sub> and NiCu<sub>5</sub>Sn<sub>5</sub>, as shown in Fig. 5(B and C), the initial discharge curves are different form that of Cu<sub>6</sub>Sn<sub>5</sub>. Slightly smaller first discharge capacity is observed and the plateau of 0.4 V is disappeared gradually on the first discharge curve. Moreover, the capacity released up 0.15 V increase and the capacity below 0.15 V decrease with the increasing amount of Ni substituted. The subsequent charge/discharge curve shows that the plateaus of 0.4 V on discharge and 0.8 V on charge became smaller and finally undistinguishable, the reversible capacity decreases gradually and the cycling ability improves with the increasing



Fig. 5. Typical first three charge/discharge curves of Li/alloy cells containing  $Cu_6Sn_5$  (A),  $Ni_{0.5}Cu_{5.5}Sn_5$  (B),  $NiCu_5Sn_5$  (C),  $Ni_2Cu_4Sn_5$  (D),  $Ni_4Cu_2Sn_5$  (E) and  $Ni_3Sn_2$  (F).

amount of Ni substituted (see Fig. 3). For the larger Ni content alloys of Ni<sub>2</sub>Cu<sub>4</sub>Sn<sub>5</sub>, the charge/discharge curve changes very much, the capacity is much less than that of Cu<sub>6</sub>Sn<sub>5</sub> and the curve shows multiple potential plateaus which is very similar with that of the Sn electrode reported by Yang et al. [17]. This profile indicates that the Li alloying mechanism is very much different with that of small Ni doped alloys, the structure of Ni<sub>2</sub>Cu<sub>4</sub>Sn<sub>5</sub> may not be stable and probably some Sn extract form the alloy during Li alloying reaction. Finally, for the alloys of Ni<sub>4</sub>Cu<sub>2</sub>Sn<sub>5</sub> and Ni<sub>3</sub>Sn<sub>2</sub>, the capacity dramatically decreases and the charge/discharge profile became slippery. Table 2 summarizes the first charge/discharge capacity and coulomb efficiency of Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> alloy electrodes. The capacity and coulomb efficiency decrease with the increasing amount of Ni content in the alloys.

Fig. 6 compares the charge–discharge cycling of Li/alloy cells containing  $Ni_xCu_{6-x}Sn_5$  (x = 0, 0.5, 1, 2, 4) and  $Ni_3Sn_2$  alloys at a current rate of 0.25 mA cm<sup>-2</sup> between 0 and 1.2 V. As shown in Fig. 4 that the cycling ability gradually improves as the Ni content increases in the alloys. The Cu<sub>6</sub>Sn<sub>5</sub> has high capacity but poor cycling ability and the Ni<sub>3</sub>Sn<sub>2</sub> has very good cycling ability but very low capacity. The low Ni doped alloys of Ni<sub>0.5</sub>Cu<sub>5.5</sub>Sn<sub>5</sub> and NiCu<sub>5</sub>Sn<sub>5</sub> have high capacity and better cycling performance than Cu<sub>6</sub>Sn<sub>5</sub>. And the Ni<sub>2</sub>Cu<sub>4</sub>Sn<sub>5</sub> and Ni<sub>4</sub>Cu<sub>2</sub>Sn<sub>5</sub> have good cycling ability with a reversible capacity of ca. 200 mAh g<sup>-1</sup> (1680 mAh ml<sup>-1</sup>).

# 3.4. The phase transformation study by first-principles calculation

In order to investigate why  $Cu_6Sn_5$  and  $Ni_3Sn_2$  alloys have the similar structure, but differ in the electrochemical

Table 2 Summaries in the first charge/discharge capacity and efficiency of the alloys

Alloys	Density (g ml <sup>-1</sup> )	First discharge capacity		First charge capacity		Coulomb efficiency (%)	
		$(\mathrm{mAh}\mathrm{g}^{-1})$	$(\mathrm{mAh}\mathrm{ml}^{-1})$	$(\mathrm{mAh}\mathrm{g}^{-1})$	$(\mathrm{mAh}\mathrm{ml}^{-1})$		
Cu <sub>6</sub> Sn <sub>5</sub>	8.35	651	5436	515	4300	79.1	
Ni0.5Cu5.5Sn5	8.33	599	4990	457	3807	76.3	
Ni1Cu5Sn5	8.34	600	5004	440	3670	73.3	
Ni2Cu4Sn5	8.41	436	3667	312	2624	71.6	
Ni <sub>4</sub> Cu <sub>2</sub> Sn <sub>5</sub>	8.55	246	2103	100	855	40.7	
Ni <sub>3</sub> Sn <sub>2</sub>	9.14	91	832	31	283	34.1	

performance: Cu<sub>6</sub>Sn<sub>5</sub> has large capacity but poor cycling stability, while Ni<sub>3</sub>Sn<sub>2</sub> has small capacity but good cycle stability, we carried out the relative energy calculations using the first-principles density-functional theory with pseudopotentials and plane wave basis (VASP). For the Cu<sub>6</sub>Sn<sub>5</sub>, the phase transformation from Cu<sub>6</sub>Sn<sub>5</sub> to the Li<sub>2</sub>CuSn-type structure occurs by a topotactic transformation in which 50% of the Sn atoms in the framework are cooperatively displaced into neighboring trigonal bipyramidal sites, thereby dislodging the interstitial Cu atoms form these sites and extruding them form the structure [18,19]. The study of Sharma et al. proposed that after the insertion of two Li atoms per Cu<sub>6</sub>Sn<sub>5</sub> formula unit, 1/6 of the Cu atoms are extruded from the structure, leading to a large structure rearrangement, to form Li<sub>2</sub>CuSn [20]. Moreover, Larcher et al. reported that the phase Li<sub>2</sub>CuSn can have a variable stoichiometry ( $Li_{2-x}CuSn$ ) during the charge (delithiation) process above 0.5 V [2]. In the structure of Cu<sub>6</sub>Sn<sub>5</sub> cells, as mentioned in Section 2.2, 20% 2d sites are occupied by Cu atoms, leaving other 80% 2d sites vacant. Based on the previous studies and the character of the Cu<sub>6</sub>Sn<sub>5</sub> cells, we first introduce a few Li atoms in the interstitial voids of 2d sites keeping the original hexagonal structure ( $P6_3/mmc$ ), and calculate the relative energies of  $Li_x Cu_6 Sn_5$  (x = 0.0, 0.5, 1.0, 2.0, 3.0) to see the reaction of lithiation is energetic preferable or hindered. During the further lithiation from Li<sub>2</sub>Cu<sub>6</sub>Sn<sub>5</sub> to the cubic Li<sub>2</sub>CuSn, we performed the calculation of the intermediate phase of  $Li_{2-x}CuSn (x = 1.25, 1.0, 0.5, 0.0, from the hexagonal to cubic$ 



Fig. 6. Capacity *vs.* cycle number of Li/alloy cells containing  $Ni_xCu_{6-x}Sn_5$  (x=0, 0.5, 1, 2, 4) and  $Ni_3Sn_2$  at a current of 0.25 mA cm<sup>-2</sup> between 0 and 2.0 V.

structure). Then, we supposed that the Cu atoms replaced by the Li atoms and extrude form the structure of Li<sub>2</sub>CuSn, leaving a compound of Li<sub>3</sub>Sn. The further lithiation lead to the formation of Li-Sn intermetallic compounds of Li<sub>7</sub>Sn<sub>2</sub> [21] and Li<sub>4.4</sub>Sn [22]. The structure details used in the calculation are listed in Table 3. In the total energy calculation, when more than one arrangement exists for one compound, the lowest energy arrangement is chosen. As shown in Fig. 7, the relative energy of the compounds become lower gradually during lithium alloying process of Cu<sub>6</sub>Sn<sub>5</sub>, indicating the lithiated compound is energetically stable and the lithiation process is energetically preferable. Moreover, when the Li content introduced to the interstitial void of Cu<sub>6</sub>Sn<sub>5</sub> matrix reaches to about 2, which means that a little more than 50% interstitial void of 2d sites have been occupied, the structural transformation energy form the hexagonal structure to the cubic Li2CuSn-tpye structure become small enough to make it happen. Also, the calculated relative energies and the experimental first charge/discharge curve are compared in Fig. 7. We can see some similarity

Crystal structure information used in the calculation

Table 3

Name	Space group	Structure	Reference
Cu <sub>6</sub> Sn <sub>5</sub>	P63/mmc	$(Cu_5)^{2a}(Cu)^{2d}(Sn_5)^{2c}$	[13]
Li0.5Cu6Sn5	P63/mmc	$(Cu_5)^{2a}(Li_{0.5}Cu)^{2d}(Sn_5)^{2c}$	
LiCu <sub>6</sub> Sn <sub>5</sub>	P63/mmc	$(Cu_5)^{2a}(LiCu)^{2d}(Sn_5)^{2c}$	
Li2Cu6Sn5	$P6_3/mmc$	$(Cu_5)^{2a}(Li_2Cu)^{2d}(Sn_5)^{2c}$	
Li3Cu6Sn5	P63/mmc	$(Cu_5)^{2a}(Li_3Cu)^{2d}(Sn_5)^{2c}$	
Li <sub>0.75</sub> CuSn	F-43m	${\rm Sn^{4a}(Li_{0.75})^{4b}Cu^{8c}}$	
LiCuSn	F-43m	Sn <sup>4a</sup> Li <sup>4b</sup> Cu <sup>8c</sup>	
Li1.5CuSn	F-43m	Sn <sup>4a</sup> Li <sup>4b</sup> (Li <sub>0.5</sub> ) <sup>8c</sup> Cu <sup>8c</sup>	
Li <sub>2</sub> CuSn	F-43m	Sn <sup>4a</sup> Li <sup>4b</sup> Li <sup>8c</sup> Cu <sup>8c</sup>	[24]
Li <sub>3</sub> Sn	F-43m	Sn <sup>4a</sup> Li <sup>4b</sup> (Li <sub>2</sub> ) <sup>8c</sup>	
$Li_{3.5}Sn(Li_7Sn_2)$	Cmmm	See ref. [21]	[21]
Li <sub>4.4</sub> Sn	F23	See ref. [22]	[22]
Ni <sub>3</sub> Sn <sub>2</sub>	P63/mmc	$(Ni_2)^{2a}(Sn_2)^{2c}Ni^{2d}$	[14]
Li <sub>0.5</sub> Ni <sub>3</sub> Sn <sub>2</sub>	P63/mmc	$(Ni_2)^{2a}(Sn_2)^{2c}Ni^{2d}(Li_{0.5})^{2d}$	
LiNi <sub>3</sub> Sn <sub>2</sub>	P63/mmc	$(Ni_2)^{2a}(Sn_2)^{2c}Ni^{2d}Li^{2d}$	
Li2Ni3Sn2	P63/mmc	$(Ni_2)^{2a}Li^{2b}(Sn_2)^{2c}Ni^{2d}Li^{2d}$	
Li <sub>0.25</sub> NiSn	F-43m	Ni <sup>4a</sup> Li <sub>0.25</sub> <sup>4b</sup> Cu <sup>8c</sup>	
Li <sub>0.5</sub> NiSn	F-43m	Ni <sup>4a</sup> Li <sub>0.5</sub> <sup>4b</sup> Cu <sup>8c</sup>	
LiNiSn	F-43m	Ni <sup>4a</sup> Li <sup>4b</sup> Cu <sup>8c</sup>	
Li <sub>2</sub> NiSn	F-43m	Ni4aLi4bLi8ccu8c	
Li <sub>3</sub> Sn	F-43m	Sn <sup>4a</sup> Li <sup>4b</sup> (Li <sub>2</sub> ) <sup>8c</sup>	
Li <sub>3.5</sub> Sn(Li <sub>7</sub> Sn <sub>2</sub> )	Cmmm	See ref. [21]	[21]
Li <sub>4.4</sub> Sn	F23	See ref. [22]	[22]



Fig. 7. Comparison between the calculated reaction path (in relative energy formation) and the experimental electrochemical voltage profile for  $Cu_6Sn_5$ .

between the calculated reaction path (in the energy format) and the experiment reaction path (in the voltage format).

Up to date, very few works have been reported about the crystal structure of the lithiated Ni-Sn alloys. Therefore, we calculated the relative energies for the Ni<sub>3</sub>Sn<sub>2</sub> and its lithiated alloys in the same way as Cu<sub>6</sub>Sn<sub>5</sub> as shown in Fig. 8. The crystal structure information used in the calculations is shown in Table 3. For the Ni<sub>3</sub>Sn<sub>2</sub> cells, there are only 50% interstitial 2d sites vacant (in this Li content level for Cu<sub>6</sub>Sn<sub>5</sub> cells, the structure become unstable and the transformation to the cubic cells begins to happen). When we introduced the Li atoms to the interstitial voids of 2d sites in which it keeps the original hexagonal structure, the relative energies of  $Li_xNi_3Sn_2$  (x = 0.5, 1.0) were almost the same with that of Ni<sub>3</sub>Sn<sub>2</sub> as shown in Fig. 8. It indicates that the Li alloying in the Ni<sub>3</sub>Sn<sub>2</sub> is very difficult. Further introducing the Li atoms to the interstitial voids of 2b sites causes the relative energy increases dramatically, which means that the intercalated Li content level of Li:Sn > 1:2 is energetically hindered for  $Ni_3Sn_2$ . The electrochemical tests show that the reversible capacity of Ni<sub>3</sub>Sn<sub>2</sub> is



Fig. 8. The relative energy calculations of the  $Ni_3Sn_2$  alloys and their lithiated products.

ca.  $30 \text{ mAh g}^{-1}$  even in the small charge/discharge current of  $0.05 \text{ mA cm}^{-2}$  (ca.  $10 \mu \text{A mg}^{-1}$ ). Moreover, we further ballmilled the as prepared Ni<sub>3</sub>Sn<sub>2</sub> alloy for 20 h at the speed of 400 r/s at the Ar gas atmosphere in order to crush the particle size, and then tested its capacity. We got a reversible capacity of  $60-70 \text{ mAh g}^{-1}$  (about 1 atom per Ni<sub>3</sub>Sn<sub>2</sub>). However, the increased capacity is very likely from the reaction of Li with the increased grain-boundary Sn atoms [23]. The detail reaction mechanism of Li with Ni<sub>3</sub>Sn<sub>2</sub> is to be further investigated.

Moreover, in order to investigate the possibility of phase transformation from the hexagonal cells to the cubic cells like Cu<sub>6</sub>Sn<sub>5</sub>, we also calculated the relative energies of the cubic  $Li_xNiSn (x=0.25, 0.5, 1.0, 2.0)$  structure (like  $Li_xCuSn$ , the model structures supposed that the same structure transformation with  $Cu_6Sn_5$  occurs in Ni<sub>3</sub>Sn<sub>2</sub>) as shown in Fig. 8. The relative energies of the cubic  $Li_xNiSn$  are higher than that of the hexagonal Li<sub>x</sub>Ni<sub>3</sub>Sn<sub>2</sub> at the same/close Li content level when Li:Sn < 1/2. Although, the relative energies of the further lithiated Li<sub>x</sub>Sn (over LiNi<sub>3</sub>Sn<sub>2</sub>) are smaller than that of LiNi<sub>3</sub>Sn<sub>2</sub> as shown in Fig. 8, the reaction cannot occur through the phase transformation from the hexagonal to cubic structure as the way of Cu<sub>6</sub>Sn<sub>5</sub> because of the high-energy barrier. Base on the above calculation, we speculated that the structure rearrangement from the hexagonal cells to the cubic cells is energetically hindered for the Ni<sub>3</sub>Sn<sub>2</sub> during the reaction with Li, and this might be the reason that results in the small capacity of Ni3Sn2 comparing with Cu<sub>6</sub>Sn<sub>5</sub>.

# 4. Conclusion

Ni doped Ni<sub>x</sub>Cu<sub>6-x</sub>Sn<sub>5</sub> (x=0, 0.5, 1, 2, 4) alloys show the similar structure, but different electrochemical performance, with that of Cu<sub>6</sub>Sn<sub>5</sub> and Ni<sub>3</sub>Sn<sub>2</sub>. The first-principles calculation calculations suggest that the Ni doped alloys are the single phase intermetallic compounds instead of the mixture phase of Cu<sub>6</sub>Sn<sub>5</sub>, Ni<sub>3</sub>Sn<sub>2</sub> and metal Sn. The electrochemical tests show that the cycle performance improves while the reversible capacity decreases with the increasing amount of Ni content. A proper amount of Ni doped alloy, NiCu<sub>5</sub>Sn<sub>5</sub> and Ni<sub>2</sub>Cu<sub>4</sub>Sn<sub>5</sub> show an improved cycling stability with a reversible capacity of  $200 \text{ mAh g}^{-1}$  (1680 mAh ml<sup>-1</sup>). The first-principles calculations suggest that the lithiation depth of Cu<sub>6</sub>Sn<sub>5</sub> can reach to Li<sub>4.4</sub>Sn, however, the reversible capacity is very small for Ni<sub>3</sub>Sn<sub>2</sub> and it may attribute to the high-energy barrier required for the structure transformation from the hexagonal structure to the cubic structure.

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